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STRESS RELEASE METHOD

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BACKGROUND OF THE INVENTION

Electrostatographic flexible imaging members are well known in the electrostatographic art. Typical flexible electrostatographic imaging members include, for example, (1) photosensitive members (photoreceptors) commonly utilized in electrophotographic (xerographic) processes and (2) electroreceptors such as ionographic imaging members for electrographic imaging systems. The flexible electrostatographic imaging members may be seamless or seamed belts. Typical electrophotographic imaging member belts comprise a charge transport layer and a charge generating layer on one side of a supporting substrate layer and an anticurl backing layer coated on the opposite side of the substrate layer. A typical electrographic imaging member belt does however have a more simple material structure; it comprises a dielectric imaging layer on one side of a supporting substrate and an anticurl backing layer on the opposite side of the substrate.

In a machine service environment, a flexible imaging member belt mounted on a belt supporting module is generally exposed to repetitive electrophotographic image cycling which subjects the outer-most charge transport layer to mechanical fatigue as the imaging member belt bends and flexes over the belt drive roller and all other belt module support rollers, as well as sliding bending contact above each backer bar's curving surface. This repetitive imaging member belt cycling leads to a gradual deterioration in the physical/mechanical integrity of the exposed outer charge transport layer leading to premature onset of charge transport layer fatigue cracking. The cracks developed in the charge transport layer as a result of dynamic belt fatiguing are found to manifest themselves into copy printout defects which thereby adversely affect the image quality on the receiving paper. In essence, the appearance of charge transport cracking cuts short the imaging member belt's intended functional life.

When a production web stock consisting of several thousand feet of coated multi-layered photoreceptor is obtained after finishing the charge transport layer coating/drying process, it is seen to spontaneously curl upwardly and required an anticurl backing layer applied to the backside of the substrate support, opposite to the

1 side having the charge transport layer, to offset the curl and render flat the
2 photoreceptor web stock. The exhibition of upward photoreceptor curling after
3 completion of charge transport layer coating has been determined to be the
4 consequence of thermal contraction mismatch between the applied charge transport
5 layer and the substrate support under the conditions of elevated temperature
6 heating/drying the wet coating and eventual cooling down to room ambient
7 temperature. Since the charge transport layer in a typical photoreceptor device has a
8 coefficient of thermal contraction approximately 3½ times larger than the substrate
9 support, it does, upon cooling down to room ambient temperature, result in greater
10 dimensional contraction than that of the substrate support causing upward
11 photoreceptor curling which thereby requires the anticurl backing layer to balance the
12 curl and provide flatness.

13 Although it may be useful in certain situations to have the anticurl backing layer
14 to complete a typical photoreceptor web stock material package, nonetheless the
15 application of anticurl backing layer onto the backside of the substrate support (for
16 counter-acting the upward curling and rendering flat the photoreceptor web stock) has
17 caused the charge transport layer to instantaneously build up an internal tension strain
18 of about 0.28% in its material matrix. After converting the web stock into a seamed
19 photoreceptor belt, the internal built-up strain is then cumulatively adding onto each
20 photoreceptor bending induced strain as the belt flexes over a variety of belt module
21 support rollers during photoreceptor belt dynamic cyclic function in a machine. The
22 consequence of this compounding strain effect is an early onset of the charge transport
23 layer fatigue cracking problem which then leads to undesirable printout defects in the
24 final image copies.

25 Thus, there is a need, addressed by the present invention, for new methods to
26 reduce or eliminate the built-up internal tension strain that can occur in certain flexible
27 multi-layer members to enhance the mechanical properties of the members.

28 Conventional multi-layer members and methods for treating such members are
29 disclosed in: Yu et al., U.S. Patent 6,165,670; Yu et al., U.S. Patent 5,606,396; Yu,
30 U.S. Patent 5,089,369; Yu, U.S. Patent 5,167,987; and Yu, U.S. Patent 4,983,481.

31 32 **SUMMARY OF THE INVENTION** 33

1 The present invention is accomplished in embodiments by providing a method
2 of treating a flexible multi-layer member exhibiting a glass transition temperature and
3 including a surface layer, the method comprising:

4 moving the member through a member path comprising: a contact zone defined
5 by contact of the member with an arcuate surface including a curved contact zone
6 region; a pre-contact member path before the contact zone; and a post-contact member
7 path after the contact zone;

8 heating sequentially each portion of the surface layer such that each of the
9 heated surface layer portions has a temperature above the glass transition temperature
10 while in the curved contact zone region; and

11 cooling sequentially each of the heated surface layer portions while in the contact
12 zone such that the temperature of each of the heated surface layer portions falls to
13 below the glass transition temperature prior to each of the heated surface layer portions
14 exiting the curved contact zone region, thereby defining a cooling region, wherein the
15 heating is accomplished in a heating region encompassing any part or all of the contact
16 zone outside the cooling region and a portion of the pre-contact member path adjacent
17 the contact zone.

18 There is also provided in embodiments a method of treating a flexible imaging
19 member comprised of in the following sequence a substrate layer, a charge generating
20 layer, and a charge transport layer wherein the charge transport layer exhibits a glass
21 transition temperature, the method comprising:

22 moving the member through a member path comprising: a contact zone defined
23 by contact of the member with an arcuate surface including a curved contact zone
24 region; a pre-contact member path before the contact zone; and a post-contact member
25 path after the contact zone;

26 heating sequentially each portion of the charge transport layer such that each of
27 the heated charge transport layer portions has a temperature above the glass transition
28 temperature while in the curved contact zone region; and

29 cooling sequentially each of the heated charge transport layer portions while in
30 the contact zone such that the temperature of each of the heated charge transport layer
31 portions falls to below the glass transition temperature prior to each of the heated
32 charge transport layer portions exiting the curved contact zone region, thereby defining
33 a cooling region, wherein the heating is accomplished in a heating region encompassing
34 any part or all of the contact zone outside the cooling region and a portion of the pre-
35 contact member path adjacent the contact zone.

BRIEF DESCRIPTION OF THE DRAWINGS

Other aspects of the present invention will become apparent as the following description proceeds and upon reference to the Figures which represent exemplary embodiments:

FIG. 1 is a schematic elevational view of a first embodiment of apparatus useful in accomplishing the present method;

FIG. 2 is a schematic elevational view of a second embodiment of apparatus useful in accomplishing the present method;

FIG. 3 is a schematic elevational view of a third embodiment of apparatus useful in accomplishing the present method;

FIG. 4 is a schematic elevational view of a fourth embodiment of apparatus useful for accomplishing the present method; and

FIG. 5 is a schematic view along the width of one embodiment of the multi-layer member.

Unless otherwise noted, the same reference numeral in different Figures refers to the same or similar feature.

DETAILED DESCRIPTION

FIG. 1 is an exemplary embodiment of apparatus useful for carrying out the present method for treating a flexible multi-layer member exhibiting a glass transition temperature ("Tg") and including a surface layer. The term "multi-layer" refers to two, three, four or more layers. The surface layer may or may not exhibit the Tg that is the subject of the present method; in embodiments, another layer of the member (such as a layer adjacent to the surface layer or a non-adjacent internal layer spaced a number of layers away from the surface layer) exhibits the Tg that is the subject of the present method while the surface layer exhibits a different Tg. As is well known, Tg is the temperature at which molecules in a rigid glass like state with restricted motion ability is transformed into a flexible state such that free molecular rotation/translation motions become predominant. The present method involves moving the member 10 through a member path 30 comprising: a contact zone 40 defined by contact of the member with an arcuate surface 210 including a curved contact zone region 40A; a pre-contact

1 member path 30A before the contact zone 40; and a post-contact member path 30B
2 after the contact zone.

3 The member 10 moves toward a free rotating component 206 (depicted in
4 embodiments as a tube) having an arcuate outer surface 210, and a chamber 209. The
5 member 10, which initially may be at ambient temperature of about 25 °C, makes an
6 entering contact at for example about 12 O'clock and conforms to the arcuate surface
7 210 of component 206. In FIG. 1, the arcuate surface is driven by the moving member
8 10 which causes the arcuate surface to rotate; in an alternate embodiment, the arcuate
9 surface is non-rotatable.

10 The member 10 may have a tension strain ranging for example from about 0.9%
11 to about 0.1%, particularly from about 0.6% to about 0.2%.

12 The speed of the member as it moves along the member path ranges for example
13 from about 1 ft/minute to about 90 ft/minute, particularly from about 5 ft/minute to
14 about 40 ft/minute.

15 The component 206 defining the arcuate surface may have an outer diameter or
16 width ranging for example from about 0.5 inch to about 5 inches, particularly from
17 about 0.5 inch to about 1 inch.

18 As the member advances into the heating region of the member path, a heating
19 source 103 heats sequentially each portion of the surface layer to a temperature above
20 the glass transition temperature while in the curved contact zone region. The heating
21 occurs only in the heating region 108 of the member path. The phrase "heating region"
22 refers to the area of the member path receiving heat from the heating source, such an
23 area encompassing any part or all of the contact zone outside the cooling region and a
24 portion of the pre-contact member path adjacent the contact zone.

25 In the depicted embodiment, the heating source 103 is a high power infrared
26 emitting tungsten halogen quartz lamp, positioned directly above the member to bring
27 an instant localized temperature elevation in the surface layer. In embodiments, the
28 heating source 103 is an integrated unit having a length covering the width of the
29 member 10 and consisting of a hemi-ellipsoidal shaped cross-section elongated
30 reflector 106 and a halogen quartz tube 105 positioned at a focal point inside the
31 reflector 106, such that all the infrared radiant energy emitted from tube 105 is reflected
32 and converges at the other focal point outside the reflector 106 to give a focused
33 heating line at the heating region 108 to quickly bring about temperature elevation.
34 The heating region provided by for example the focused heating line may range in
35 width (that is, in the direction of member movement) from about 3 mm to about 1 cm,

1 particularly from about 6 mm to about 12 mm. Alternatively, the heating source may
2 be a laser such as a carbon dioxide laser.

3 The heating raises each of the heated surface layer portions to a temperature
4 ranging from about 5 to about 40 degrees C above the glass transition temperature,
5 particularly from about 10 to about 20 degrees C above the glass transition temperature.
6 The electrical power input to the heating source can be adjusted incrementally to
7 produce the desired heat energy output. The temperature of the member can be
8 monitored with an infrared camera.

9 The present method then cools sequentially each of the heated surface layer
10 portions while in the contact zone such that the temperature of each of the heated
11 surface layer portions falls to below the glass transition temperature prior to each of the
12 heated surface layer portions exiting the curved contact zone region, thereby defining a
13 cooling region. The phrase "cooling region" refers to the area of the member path
14 after the heating region and before the post-contact member path, even including any
15 place where the temperature of the surface layer portions has not yet fallen below the
16 glass transition temperature. It is apparent that the "cooling region" excludes any place
17 in the member path subjected to heating by the heating source.

18 After advancing into the cooling region, each of the heated surface layer portions
19 after exposure to the heating source 103 will then quickly cool down when the member
20 is transported away from the heat source 103, through for instance direct heat
21 conduction away from the member to component 206 as well as heat convection to the
22 ambient air (due to movement of the member along the member path). A final cooling
23 down can be achieved by an optional cooling system 203 including a free rotating soft
24 hydrophilic foam roll 50 (saturated with a cooling liquid) making compression contact
25 with the member at a position spanning about 4 O'clock to about 6 O'clock to assure
26 temperature lowering of the exiting surface layer portions to a temperature of at least
27 about 20 °C (particularly at least about 40 °C) below the glass transition temperature to
28 yield permanent stress or strain release. In embodiments of the cooling system 203, the
29 hydrophilic cooling roll 50 is a soft idling foam roll having a free rotating axial shaft 51
30 and is partially submersed, but totally saturated, in a cooling liquid bath 52 (e.g., water,
31 alcohol, and the like, or a mixture thereof) to provide effective cooling result. The
32 temperature of the cooling liquid bath ranges for example from about 0 to about 25
33 degrees C, particularly from about 5 to about 10 degrees C. The annular chamber 209
34 of the treatment component 206 can include just air at ambient temperature; or a
35 coolant such as sub-cooled water, liquid nitrogen, alcohol and the like, can be passed

1 through the annular chamber 209. The temperature of the water and/or alcohol coolant
2 passing through the chamber ranges for example from about 0 to about 25 degrees C,
3 particularly from about 5 to about 10 degrees C.

4 In embodiments, to enhance the stress or strain release effect of the present
5 method, the member can be transported through the member path at a speed described
6 herein such that the heat extraction from the member by the contacting cooling foam
7 roll 50 is effectual to bring down the temperature of each of the surface layer portions
8 to significantly lower than the T_g prior to each of the surface layer portions exiting the
9 curved contact zone region.

10 FIG. 2 is another embodiment of apparatus useful for carrying out the present
11 invention, in which the cooling system 203 utilized in FIG. 1 is replaced with a
12 different cooling system 203A depicted as an air impinging knife. Besides air, cooling
13 by cooling system 203A may also be achieved by using impinging CO₂ snow, super-
14 cooled nitrogen gas, liquid water, or alcohol and the like. Since impinging air, nitrogen,
15 CO₂, liquid alcohol, or liquid water is a forced convection cooling process, the
16 impinging cooling medium can quickly bring the temperature of the heated surface
17 layer portions down to below the T_g. The temperature of the impinging cooling
18 medium, if gaseous, can range for example from about -10 °C to about 20 °C,
19 particularly from about -5 °C to about 5 °C. However, for a high heat conducting
20 liquid such as water or alcohol, the temperature of the impinging liquid is for example
21 from about 2 °C to about 25 °C, particularly from about 5 °C to about 10 °C.

22 Thus, as discussed herein, cooling can include transferring heat away from the
23 member via heat conduction through the arcuate surface and also via heat convection to
24 ambient air (e.g., forced heat convection using for example a fan or natural heat
25 convection). In embodiments, cooling further includes transferring heat away from the
26 member via heat conduction or heat convection to a coolant other than ambient air. In
27 other embodiments, cooling is accomplished by relying only on transferring heat away
28 from the member via heat conduction through the arcuate surface and/or via heat
29 convection to ambient air, without transferring heat away from the member via heat
30 conduction or heat convection to a coolant other than ambient air, i.e., cooling system
31 203/203A is absent in certain embodiments.

32 The heating and cooling features of the present method are discussed with
33 respect to the surface layer whether that is the top layer or the bottom layer of the
34 member. Due to the phenomenon of heating conduction, however, the heating and
35 cooling of the surface layer may affect any layer or layers above or below the surface

1 layer in a manner similar to the heating/cooling experienced by the surface layer. So
2 the present method can be used in embodiments to treat via heat conduction other layer
3 or layers of the member in addition to the surface layer. To treat one or more additional
4 layers where each layer has a glass transition temperature different from that of the
5 surface layer, one applies sufficient heat to the member in the heating region to heat the
6 surface layer and the additional layer(s) to above the highest glass transition
7 temperature of the various layers targeted for stress release. Then, according to the
8 present method, one cools in the cooling region the surface layer and the additional
9 layer(s) to below the lowest glass transition temperature of the various layers targeted
10 for stress release.

11 In certain embodiments, where the surface layer has a T_g higher than the T_g of
12 an adjacent layer and the adjacent layer is the layer targeted for stress release, the
13 present method applies heat in the heating region to heat the surface layer and the
14 adjacent layer to a temperature that exceeds the T_g of the adjacent layer; it is optional
15 to make the temperature exceed the T_g of the surface layer as well if the surface layer is
16 not targeted for stress release. Then, one cools in the cooling region the surface layer
17 and the adjacent layer to below the T_g of the adjacent layer.

18 Thus, in embodiments, the member further includes an additional layer, wherein
19 there occurs the following: (1) due to heat conduction within the member, the heating
20 sequentially of each portion of the surface layer also causes heating sequentially of each
21 portion of the additional layer such that each of the heated additional layer portions has
22 a temperature above the glass transition temperature while in the curved contact zone
23 region; and (2) wherein due to heat conduction within the member, the cooling
24 sequentially of each of the heated surface layer portions also causes cooling
25 sequentially of each portion of the additional layer such that the temperature of each of
26 the heated additional layer portions falls to below the glass transition temperature prior
27 to each of the heated additional layer portions exiting the curved contact zone region.

28 The glass transition temperatures of the various layers of the member can differ
29 by a value ranging for example from about 5 to about 30 degrees C, particularly from
30 about 10 to about 20 degrees C.

31 In FIGS. 1-2, the contact zone 40 consists only of the curved contact zone
32 region 40A. In embodiments, the contact zone can include one or two straight contact
33 zone regions adjacent the curved contact zone region. FIG. 3 depicts an elongated non-
34 rotating component 206A (with chamber 209A) defining an arcuate surface 210A
35 between two straight surfaces 210B. Accordingly, the curved contact zone region 40A

1 disposed between the two straight contact zone regions 40B collectively are contact
2 zone 40.

3 The member contacts the arcuate surface at a wrap angle ranging for example
4 from about 30 to about 350 degrees, particularly from about 30 to about 180 degrees.
5 A wrap angle of 180 degrees is illustrated in FIGS. 1-3. FIG. 4 depicts a wrap angle
6 much greater than 180 degrees by engaging the member 10 with component 206 and a
7 rotating roller 207 to create a long contact zone 40.

8 The member may be any flexible multi-layer component that can be cycled over
9 one or more rollers. The member can be an imaging member such as an
10 electrostatographic imaging member, and especially an electrophotographic imaging
11 member (e.g., photoreceptor). In other embodiments, the member can be a conveyor
12 belt, an intermediate image transfer belt, or the like.

13 In embodiments, the member is moved at a constant speed along the member
14 path including through the contact zone. The phrase "constant speed" means steady
15 movement without stop and go movement, pausing or varying the speed. In other
16 embodiments, the member is moved at a non-constant speed along the member path
17 including through the contact zone. The phrase "non-constant speed" means stop and
18 go movement, pausing or varying the speed. Each pause may last for example from
19 about 3 seconds to about 1 minute. The member may be subjected to the present
20 method one, two, or more times; in embodiments, the member is subjected to the
21 present method only one time.

22 The present method reduces or eliminates the built-up internal tension strain
23 within the member, thereby providing any or all of the following benefits: (1)
24 eliminates or reduces edge curling; (2) surface layer cracking life extension; and (3)
25 renders optional the use of an anticurl backing layer for an imaging member.

26 Additional processing of the member can occur using conventional techniques.
27 For example, where the member is an imaging member web-stock, one can form a
28 seamed imaging belt using the joining techniques described for example in U.S. Patent
29 5,688,355, the disclosure of which is totally incorporated herein by reference.

30 In FIG. 5, an exemplary imaging member is provided with an anti-curl layer 1, a
31 supporting substrate 2, an electrically conductive ground plane 3, a charge blocking
32 layer 4, an adhesive layer 5, a charge generating layer 6, a charge transport layer 7, an
33 optional overcoating layer 8, and a ground strip 9.

The Anti-Curl Layer

For some applications, an optional anti-curl layer 1 can be provided, which comprises film-forming organic or inorganic polymers that are electrically insulating or slightly semi-conductive. The anti-curl layer provides flatness and/or abrasion resistance.

Anti-curl layer 1 can be formed at the back side of the substrate 2, opposite the imaging layers. The anti-curl layer may include, in addition to the film-forming resin, an adhesion promoter polyester additive. Examples of film-forming resins useful as the anti-curl layer include, but are not limited to, polyacrylate, polystyrene, poly(4,4'-isopropylidene diphenylcarbonate), poly(4,4'-cyclohexylidene diphenylcarbonate), mixtures thereof and the like.

Additives may be present in the anti-curl layer in the range of about 0.5 to about 40 weight percent of the anti-curl layer. Preferred additives include organic and inorganic particles which can further improve the wear resistance and/or provide charge relaxation property. Preferred organic particles include Teflon powder, carbon black, and graphite particles. Preferred inorganic particles include insulating and semiconducting metal oxide particles such as silica, zinc oxide, tin oxide and the like. Another semiconducting additive is the oxidized oligomer salts as described in U.S. Patent 5,853,906. The preferred oligomer salts are oxidized N, N, N', N'-tetra-p-tolyl-4,4'-biphenyldiamine salt.

Typical adhesion promoters useful as additives include, but are not limited to, duPont 49,000 (duPont), Vitel PE-100, Vitel PE-200, Vitel PE-307 (Goodyear), mixtures thereof and the like. Usually from about 1 to about 15 weight percent adhesion promoter is selected for film-forming resin addition, based on the weight of the film-forming resin.

The thickness of the anti-curl layer is typically from about 3 micrometers to about 35 micrometers and, preferably, about 14 micrometers. However, thicknesses outside these ranges can be used.

The anti-curl coating can be applied as a solution prepared by dissolving the film-forming resin and the adhesion promoter in a solvent such as methylene chloride. The solution may be applied to the rear surface of the supporting substrate (the side opposite the imaging layers) of the photoreceptor device, for example, by web coating or by other methods known in the art. Coating of the overcoat layer and the anti-curl layer can be accomplished simultaneously by web coating onto a multi-layer

1 photoreceptor comprising a charge transport layer, charge generation layer, adhesive
2 layer, blocking layer, ground plane and substrate. The wet film coating is then dried to
3 produce the anti-curl layer 1.

4 5 The Supporting Substrate

6
7 As indicated above, the photoreceptors are prepared by first providing a substrate
8 2, i.e., a support. The substrate can be opaque or substantially transparent and can
9 comprise any of numerous suitable materials having given required mechanical
10 properties.

11 The substrate can comprise a layer of electrically non-conductive material or a
12 layer of electrically conductive material, such as an inorganic or organic composition. If
13 a non-conductive material is employed, it is necessary to provide an electrically
14 conductive ground plane over such non-conductive material. If a conductive material is
15 used as the substrate, a separate ground plane layer may not be necessary.

16 The substrate is flexible and can have any of a number of different
17 configurations, such as, for example, a sheet, a scroll, an endless flexible belt, a web,
18 and the like.

19 Various resins can be used as electrically non-conducting materials, including,
20 but not limited to, polyesters, polycarbonates, polyamides, polyurethanes, and the like.
21 Such a substrate preferably comprises a commercially available biaxially oriented
22 polyester known as MYLAR™, available from E. I. duPont de Nemours & Co.,
23 MELINEX™, available from ICI Americas Inc., or HOSTAPHAN™, available from
24 American Hoechst Corporation. Other materials of which the substrate may be
25 comprised include polymeric materials, such as polyvinyl fluoride, available as
26 TEDLAR™ from E. I. duPont de Nemours & Co., polyethylene and polypropylene,
27 available as MARLEX™ from Phillips Petroleum Company, polyphenylene sulfide,
28 RYTON™ available from Phillips Petroleum Company, and polyimides, available as
29 KAPTON™ from E. I. duPont de Nemours & Co. The photoreceptor can also be coated
30 on an insulating plastic drum, provided a conducting ground plane has previously been
31 coated on its surface, as described above. Such substrates can either be seamed or
32 seamless.

33 When a conductive substrate is employed, any suitable conductive material can
34 be used. For example, the conductive material can include, but is not limited to, metal
35 flakes, powders or fibers, such as aluminum, titanium, nickel, chromium, brass, gold,

1 stainless steel, carbon black, graphite, or the like, in a binder resin including metal
2 oxides, sulfides, silicides, quaternary ammonium salt compositions, conductive
3 polymers such as polyacetylene or its pyrolysis and molecular doped products, charge
4 transfer complexes, and polyphenyl silane and molecular doped products from
5 polyphenyl silane.

6 The preferred thickness of the substrate depends on numerous factors, including
7 the required mechanical performance and economic considerations. The thickness of
8 the substrate is typically within a range of from about 65 micrometers to about 150
9 micrometers, and preferably is from about 75 micrometers to about 125 micrometers
10 for optimum flexibility and minimum induced surface bending stress when cycled
11 around small diameter rollers, e.g., 19 mm diameter rollers. The substrate for a flexible
12 belt can be of substantial thickness, for example, over 200 micrometers, or of minimum
13 thickness, for example, less than 50 micrometers, provided there are no adverse effects
14 on the final photoconductive device.

15 The surface of the substrate to which a layer is to be applied is preferably cleaned
16 to promote greater adhesion of such a layer. Cleaning can be effected, for example, by
17 exposing the surface of the substrate layer to plasma discharge, ion bombardment, and
18 the like. Other methods, such as solvent cleaning, can be used.

19 Regardless of any technique employed to form a metal layer, a thin layer of metal
20 oxide generally forms on the outer surface of most metals upon exposure to air. Thus,
21 when other layers overlying the metal layer are characterized as "contiguous" layers, it
22 is intended that these overlying contiguous layers may, in fact, contact a thin metal
23 oxide layer that has formed on the outer surface of the oxidizable metal layer.

24 The Electrically Conductive Ground Plane

26
27 As stated above, photoreceptors prepared in accordance with the present
28 invention comprise a substrate that is either electrically conductive or electrically non-
29 conductive. When a non-conductive substrate is employed, an electrically conductive
30 ground plane 3 must be employed, and the ground plane acts as the conductive layer.
31 When a conductive substrate is employed, the substrate can act as the conductive layer,
32 although a conductive ground plane may also be provided.

33 If an electrically conductive ground plane is used, it is positioned over the
34 substrate. Suitable materials for the electrically conductive ground plane include, but
35 are not limited to, aluminum, zirconium, niobium, tantalum, vanadium, hafnium,

1 titanium, nickel, stainless steel, chromium, tungsten, molybdenum, copper, and the
2 like, and mixtures and alloys thereof. In embodiments, aluminum, titanium, and
3 zirconium are preferred.

4 The ground plane can be applied by known coating techniques, such as solution
5 coating, vapor deposition, and sputtering. A preferred method of applying an
6 electrically conductive ground plane is by vacuum deposition. Other suitable methods
7 can also be used.

8 Preferred thicknesses of the ground plane are within a substantially wide range,
9 depending on the optical transparency and flexibility desired for the
10 electrophotoconductive member. Accordingly, for a flexible photoresponsive imaging
11 device, the thickness of the conductive layer is preferably between about 20 angstroms
12 and about 750 angstroms; more preferably, from about 50 angstroms to about 200
13 angstroms for an optimum combination of electrical conductivity, flexibility, and light
14 transmission. However, the ground plane can, if desired, be opaque.

15 The Charge Blocking Layer

16
17
18 After deposition of any electrically conductive ground plane layer, a charge
19 blocking layer 4 can be applied thereto. Electron blocking layers for positively charged
20 photoreceptors permit holes from the imaging surface of the photoreceptor to migrate
21 toward the conductive layer. For negatively charged photoreceptors, any suitable hole
22 blocking layer capable of forming a barrier to prevent hole injection from the
23 conductive layer to the opposite photoconductive layer can be utilized.

24 If a blocking layer is employed, it is preferably positioned over the electrically
25 conductive layer. The term "over," as used herein in connection with many different
26 types of layers, should be understood as not being limited to instances wherein the
27 layers are contiguous. Rather, the term refers to relative placement of the layers and
28 encompasses the inclusion of unspecified intermediate layers.

29 The blocking layer 4 can include polymers, such as polyvinyl butyral, epoxy
30 resins, polyesters, polysiloxanes, polyamides, polyurethanes, and the like; nitrogen-
31 containing siloxanes or nitrogen-containing titanium compounds, such as
32 trimethoxysilyl propyl ethylene diamine, N-beta(aminoethyl) gamma-aminopropyl
33 trimethoxy silane, isopropyl 4-aminobenzene sulfonyl titanate, di(dodecylbenzene
34 sulfonyl) titanate, isopropyl di(4-aminobenzoyl)isostearoyl titanate, isopropyl tri(N-
35 ethyl amino) titanate, isopropyl trianthranil titanate, isopropyl tri(N,N-dimethyl-ethyl

1 amino) titanate, titanium-4-amino benzene sulfonate oxyacetate, titanium 4-
2 aminobenzoate isostearate oxyacetate, gamma-aminobutyl methyl dimethoxy silane,
3 gamma-aminopropyl methyl dimethoxy silane, and gamma-aminopropyl trimethoxy
4 silane, as disclosed in U.S. Patents 4,338,387, 4,286,033, and 4,291,110.

5 A preferred hole blocking layer comprises a reaction product of a hydrolyzed
6 silane or a mixture of hydrolyzed silanes and the oxidized surface of a metal ground
7 plane layer. The oxidized surface inherently forms on the outer surface of most metal
8 ground plane layers when exposed to air after deposition. This combination enhances
9 electrical stability at low relative humidity. The hydrolyzed silanes can then be used as
10 is well known in the art. For example, see U.S. Patent 5,091,278 to Teuscher et al.

11 The blocking layer 4 should be continuous and can have a thickness of up to 2
12 micrometers depending on the type of material used.

13 However, the blocking layer preferably has a thickness of less than about 0.5
14 micrometer because greater thicknesses may lead to undesirably high residual voltage.
15 A blocking layer between about 0.005 micrometer and about 0.3 micrometer is
16 satisfactory for most applications because charge neutralization after the exposure step
17 is facilitated and good electrical performance is achieved. A thickness between about
18 0.03 micrometer and about 0.06 micrometer is preferred for blocking layers for
19 optimum electrical behavior.

20 The blocking layer 4 can be applied by any suitable technique, such as spraying,
21 dip coating, draw bar coating, gravure coating, silk screening, air knife coating, reverse
22 roll coating, vacuum deposition, chemical treatment, and the like. For convenience in
23 obtaining thin layers, the blocking layer is preferably applied in the form of a dilute
24 solution, with the solvent being removed after deposition of the coating by
25 conventional techniques, such as by vacuum, heating, and the like. Generally, a weight
26 ratio of blocking layer material and solvent of between about 0.5:100 to about 5.0:100
27 is satisfactory for spray coating.

28 29 The Adhesive Layer

30
31 An intermediate layer 5 between the blocking layer and the charge generating
32 layer may, if desired, be provided to promote adhesion.

33 Additionally, adhesive layers can be provided, if necessary, between any of the
34 layers in the photoreceptors to ensure adhesion of any adjacent layers. Alternatively, or
35 in addition, adhesive material can be incorporated into one or both of the respective

1 layers to be adhered. Such optional adhesive layers preferably have thicknesses of
2 about 0.001 micrometer to about 0.2 micrometer. Such an adhesive layer can be
3 applied, for example, by dissolving adhesive material in an appropriate solvent,
4 applying by hand, spraying, dip coating, draw bar coating, gravure coating, silk
5 screening, air knife coating, vacuum deposition, chemical treatment, roll coating, wire
6 wound rod coating, and the like, and drying to remove the solvent. Suitable adhesives
7 include, for example, film-forming polymers, such as polyester, dupont 49,000
8 (available from E. I. duPont de Nemours & Co.), Vitel PE-100 (available from
9 Goodyear Tire and Rubber Co.), polyvinyl butyral, polyvinyl pyrrolidone,
10 polyurethane, polymethyl methacrylate, and the like.

11 12 The Imaging Layer(s) 13

14 In fabricating a photosensitive imaging member, a charge generating material
15 (CGM) and a charge transport material (CTM) may be deposited onto the substrate
16 surface either in a laminate type configuration where the CGM and CTM are in
17 different layers or in a single layer configuration where the CGM and CTM are in the
18 same layer along with a binder resin. The photoreceptors embodying the present
19 invention can be prepared by applying over the electrically conductive layer the charge
20 generation layer 6 and, optionally, a charge transport layer 7. In embodiments, the
21 charge generation layer and, when present, the charge transport layer, may be applied in
22 either order.

23 Illustrative organic photoconductive charge generating materials include azo
24 pigments such as Sudan Red, Dian Blue, Janus Green B, and the like; quinone
25 pigments such as Algol Yellow, Pyrene Quinone, Indanthrene Brilliant Violet RRP,
26 and the like; quinocyanine pigments; perylene pigments such as benzimidazole
27 perylene; indigo pigments such as indigo, thioindigo, and the like; bisbenzoimidazole
28 pigments such as Indofast Orange, and the like; phthalocyanine pigments such as
29 copper phthalocyanine, aluminochloro-phthalocyanine, hydroxygallium
30 phthalocyanine, and the like; quinacridone pigments; or azulene compounds. Suitable
31 inorganic photoconductive charge generating materials include for example cadmium
32 sulfide, cadmium sulfoselenide, cadmium selenide, crystalline and amorphous
33 selenium, lead oxide and other chalcogenides. Alloys of selenium are encompassed by
34 embodiments of the instant invention and include for instance selenium-arsenic,
35 selenium-tellurium-arsenic, and selenium-tellurium.

1 Any suitable inactive resin binder material may be employed in the charge
2 generating layer. Typical organic resinous binders include polycarbonates, acrylate
3 polymers, methacrylate polymers, vinyl polymers, cellulose polymers, polyesters,
4 polysiloxanes, polyamides, polyurethanes, epoxies, polyvinylacetals, and the like.

5 To create a dispersion useful as a coating composition, a solvent is used with the
6 charge generating material and the optional resin binder. The solvent can be for example
7 cyclohexanone, methyl ethyl ketone, tetrahydrofuran, alkyl acetate, and mixtures thereof.
8 The alkyl acetate (such as butyl acetate and amyl acetate) can have from 3 to 5 carbon
9 atoms in the alkyl group. The amount of solvent in the composition ranges for example
10 from about 70% to about 98% by weight, based on the weight of the composition.

11 The amount of the charge generating material in the composition ranges for
12 example from about 0.5% to about 5% by weight, based on the weight of the
13 composition including a solvent. The amount of photoconductive particles (i.e, the
14 charge generating material) dispersed in a dried photoconductive coating varies to some
15 extent with the specific photoconductive pigment particles selected. For example,
16 when phthalocyanine organic pigments such as titanyl phthalocyanine and metal-free
17 phthalocyanine are utilized, satisfactory results are achieved when the dried
18 photoconductive coating comprises between about 50 percent by weight and about 90
19 percent by weight of all phthalocyanine pigments based on the total weight of the dried
20 photoconductive coating. Since the photoconductive characteristics are affected by the
21 relative amount of pigment per square centimeter coated, a lower pigment loading may
22 be utilized if the dried photoconductive coating layer is thicker. Conversely, higher
23 pigment loadings are desirable where the dried photoconductive layer is to be thinner.

24 Generally, satisfactory results are achieved with an average photoconductive
25 particle size of less than about 0.6 micrometer when the photoconductive coating is
26 applied by dip coating. Preferably, the average photoconductive particle size is less
27 than about 0.4 micrometer. Preferably, the photoconductive particle size is also less
28 than the thickness of the dried photoconductive coating in which it is dispersed.

29 The weight ratio of the charge generating material ("CGM") to present polymeric
30 compound ("binder") ranges from 40 (CGM):60 (binder) to 70 (CGM):30 (binder).

31 For multilayered photoreceptors comprising a charge generating layer (also
32 referred herein as a photoconductive layer) and a charge transport layer, satisfactory
33 results may be achieved with a dried photoconductive layer coating thickness of
34 between about 0.1 micrometer and about 10 micrometers. Preferably, the
35 photoconductive layer thickness is between about 0.2 micrometer and about 4

1 micrometers. However, these thicknesses also depend upon the pigment loading. Thus,
2 higher pigment loadings permit the use of thinner photoconductive coatings.
3 Thicknesses outside these ranges can be selected providing the objectives of the present
4 invention are achieved.

5 Any suitable technique may be utilized to disperse the photoconductive particles
6 in the binder and solvent of the coating composition. Typical dispersion techniques
7 include, for example, ball milling, roll milling, milling in vertical attritors, sand
8 milling, and the like. Typical milling times using a ball roll mill is between about 4
9 and about 6 days.

10 Charge transport materials include an organic polymer or non-polymeric
11 material capable of supporting the injection of photoexcited holes or transporting
12 electrons from the photoconductive material and allowing the transport of these holes
13 or electrons through the organic layer to selectively dissipate a surface charge.
14 Illustrative charge transport materials include for example a positive hole transporting
15 material selected from compounds having in the main chain or the side chain a
16 polycyclic aromatic ring such as anthracene, pyrene, phenanthrene, coronene, and the
17 like, or a nitrogen-containing hetero ring such as indole, carbazole, oxazole,
18 isoxazole, thiazole, imidazole, pyrazole, oxadiazole, pyrazoline, thiadiazole, triazole,
19 and hydrazone compounds. Typical hole transport materials include electron donor
20 materials, such as carbazole; N-ethyl carbazole; N-isopropyl carbazole; N-phenyl
21 carbazole; tetraphenylpyrene; 1-methyl pyrene; perylene; chrysene; anthracene;
22 tetraphene; 2-phenyl naphthalene; azopyrene; 1-ethyl pyrene; acetyl pyrene; 2,3-
23 benzochrysene; 2,4-benzopyrene; 1,4-bromopyrene; poly (N-vinylcarbazole);
24 poly(vinylpyrene); poly(-vinyltetraphene); poly(vinyltetracene) and
25 poly(vinylperylene). Suitable electron transport materials include electron acceptors
26 such as 2,4,7-trinitro-9-fluorenone; 2,4,5,7-tetranitro-fluorenone; dinitroanthracene;
27 dinitroacridene; tetracyanopyrene and dinitroanthraquinone.

28 Any suitable inactive resin binder may be employed in the charge transport
29 layer. Typical inactive resin binders soluble in methylene chloride include
30 polycarbonate resin, polyvinylcarbazole, polyester, polyarylate, polystyrene,
31 polyacrylate, polyether, polysulfone, and the like. Molecular weights can vary from
32 about 20,000 to about 1,500,000.

33 Any suitable technique may be utilized to apply the charge transport layer and the
34 charge generating layer to the substrate. Typical coating techniques include dip coating,
35 roll coating, spray coating, rotary atomizers, and the like. The coating techniques may

1 use a wide concentration of solids. Preferably, the solids content is between about 2
2 percent by weight and 8 percent by weight based on the total weight of the dispersion.
3 The expression "solids" refers to the photoconductive pigment particles and binder
4 components of the charge generating coating dispersion and to the charge transport
5 particles and binder components of the charge transport coating dispersion. These
6 solids concentrations are useful in dip coating, roll, spray coating, and the like.
7 Generally, a more concentrated coating dispersion is preferred for roll coating. Drying
8 of the deposited coating may be effected by any suitable conventional technique such as
9 oven drying, infra-red radiation drying, air drying and the like. Generally, the thickness
10 of the charge generating layer ranges from about 0.1 micrometer to about 3
11 micrometers and the thickness of the transport layer is between about 5 micrometers to
12 about 100 micrometers, but thicknesses outside these ranges can also be used. In
13 general, the ratio of the thickness of the charge transport layer to the charge generating
14 layer is preferably maintained from about 2:1 to 200:1 and in some instances as great as
15 400:1.

16 17 The Overcoating Layer

18
19 Embodiments in accordance with the present invention can, optionally, further
20 include an overcoating layer or layers 8, which, if employed, are positioned over the
21 charge generation layer or over the charge transport layer. This layer comprises organic
22 polymers or inorganic polymers that are electrically insulating or slightly semi-
23 conductive.

24 Such a protective overcoating layer includes a film forming resin binder
25 optionally doped with a charge transport material.

26 Any suitable film-forming inactive resin binder can be employed in the
27 overcoating layer. For example, the film forming binder can be any of a number of
28 resins, such as polycarbonates, polyarylates, polystyrene, polysulfone, polyphenylene
29 sulfide, polyetherimide, polyphenylene vinylene, and polyacrylate. The resin binder
30 used in the overcoating layer can be the same or different from the resin binder used in
31 the anti-curl layer or in any charge transport layer that may be present. The binder resin
32 should preferably have a Young's modulus greater than about 2×10^5 psi, a break
33 elongation no less than 10%, and a glass transition temperature greater than about 150
34 degrees C. The binder may further be a blend of binders. The preferred polymeric film
35 forming binders include MAKROLON™, a polycarbonate resin having a weight

1 average molecular weight of about 50,000 to about 100,000 available from
2 Farbenfabriken Bayer A. G., 4,4'-cyclohexylidene diphenyl polycarbonate, available
3 from Mitsubishi Chemicals, high molecular weight LEXAN™ 135, available from the
4 General Electric Company, ARDEL™ polyarylate D-100, available from Union
5 Carbide, and polymer blends of MAKROLON™ and the copolyester VITEL™ PE-100
6 or VITEL™ PE-200, available from Goodyear Tire and Rubber Co.

7 In embodiments, a range of about 1% by weight to about 10% by weight of the
8 overcoating layer of VITEL™ copolymer is preferred in blending compositions, and,
9 more preferably, about 3% by weight to about 7% by weight. Other polymers that can
10 be used as resins in the overcoat layer include DUREL™ polyarylate from Celanese,
11 polycarbonate copolymers LEXAN™ 3250, LEXAN™ PPC 4501, and LEXAN™ PPC
12 4701 from the General Electric Company, and CALIBRE™ from Dow.

13 Additives may be present in the overcoating layer in the range of about 0.5 to
14 about 40 weight percent of the overcoating layer. Preferred additives include organic
15 and inorganic particles which can further improve the wear resistance and/or provide
16 charge relaxation property. Preferred organic particles include Teflon powder, carbon
17 black, and graphite particles. Preferred inorganic particles include insulating and
18 semiconducting metal oxide particles such as silica, zinc oxide, tin oxide and the like.
19 Another semiconducting additive is the oxidized oligomer salts as described in U.S.
20 Patent 5,853,906. The preferred oligomer salts are oxidized N, N, N', N'-tetra-p-tolyl-
21 4,4'-biphenyldiamine salt.

22 The overcoating layer can be prepared by any suitable conventional technique
23 and applied by any of a number of application methods. Typical application methods
24 include, for example, hand coating, spray coating, web coating, dip coating and the
25 like. Drying of the deposited coating can be effected by any suitable conventional
26 techniques, such as oven drying, infrared radiation drying, air drying, and the like.

27 Overcoatings of from about 3 micrometers to about 7 micrometers are effective
28 in preventing charge transport molecule leaching, crystallization, and charge transport
29 layer cracking. Preferably, a layer having a thickness of from about 3 micrometers to
30 about 5 micrometers is employed.

31 The Ground Strip

32
33
34 Ground strip 9 can comprise a film-forming binder and electrically conductive
35 particles. Cellulose may be used to disperse the conductive particles. Any suitable

1 electrically conductive particles can be used in the electrically conductive ground strip
2 layer 9. The ground strip 9 can, for example, comprise materials that include those
3 enumerated in U.S. Patent 4,664,995. Typical electrically conductive particles include,
4 but are not limited to, carbon black, graphite, copper, silver, gold, nickel, tantalum,
5 chromium, zirconium, vanadium, niobium, indium tin oxide, and the like.

6 The electrically conductive particles can have any suitable shape. Typical shapes
7 include irregular, granular, spherical, elliptical, cubic, flake, filament, and the like.
8 Preferably, the electrically conductive particles should have a particle size less than the
9 thickness of the electrically conductive ground strip layer to avoid an electrically
10 conductive ground strip layer having an excessively irregular outer surface. An average
11 particle size of less than about 10 micrometers generally avoids excessive protrusion of
12 the electrically conductive particles at the outer surface of the dried ground strip layer
13 and ensures relatively uniform dispersion of the particles through the matrix of the
14 dried ground strip layer. Concentration of the conductive particles to be used in the
15 ground strip depends on factors such as the conductivity of the specific conductive
16 materials utilized.

17 In embodiments, the ground strip layer may have a thickness of from about 7
18 micrometers to about 42 micrometers and, preferably, from about 14 micrometers
19 to about 27 micrometers.

20 The invention will now be described in detail with respect to specific preferred
21 embodiments thereof, it being understood that these examples are intended to be
22 illustrative only and the invention is not intended to be limited to the materials,
23 conditions, or process parameters recited herein. All percentages and parts are by
24 weight unless otherwise indicated.

25 26 CONTROL EXAMPLE I

27
28 A flexible electrophotographic imaging member web stock was prepared by
29 providing a 0.01 micrometer thick titanium layer coated onto a flexible biaxially
30 oriented polynaphthalate substrate support layer (available from ICI Americas, Inc.)
31 having a thermal contraction coefficient of about $1.8 \times 10^{-5}/^{\circ}\text{C}$, a glass transition
32 temperature T_g of 130°C , and a thickness of 3-1/2 mils or 88.7 micrometers, and
33 applying thereto, by a gravure coating process, a solution containing 10 grams gamma-
34 aminopropyltriethoxy silane, 10.1 grams distilled water, 3 grams acetic acid, 684.8
35 grams of 200 proof denatured alcohol and 200 grams heptane. This layer was then

1 dried at 125°C in a forced air oven. The resulting blocking layer had an average dry
2 thickness of 0.05 micrometer measured with an ellipsometer.

3 An adhesive interface layer was then extrusion coated by applying to the blocking
4 layer a wet coating containing 5 percent by weight based on the total weight of the
5 solution of polyester adhesive (Mor-Ester 49,000, available from Morton International,
6 Inc.) in a 70:30 volume ratio mixture of tetrahydrofuran/cyclohexanone. The resulting
7 adhesive interface layer, after passing through an oven, had a dry thickness of 0.095
8 micrometer. The adhesive interface layer was thereafter coated, by extrusion, with a
9 photogenerating layer containing 7.5 percent by volume trigonal Se, 25 percent by
10 volume N,N'-diphenyl-N,N'-bis(3-methylphenyl)-1,1'-biphenyl-4,4'-diamine, and 67.5
11 percent by volume polyvinylcarbazole. This photogenerating layer was prepared by
12 introducing 8 grams polyvinyl carbazole and 140 mls of a 1:1 volume ratio of a mixture
13 of tetrahydrofuran and toluene into a 20 oz. amber bottle. To this solution was added 8
14 grams of trigonal selenium and 1,000 grams of 1/8 inch (3.2 millimeter) diameter
15 stainless steel shot. This mixture was then placed on a ball mill for 72 to 96 hours.
16 Subsequently, 50 grams of polyvinyl carbazole and 2.0 grams of N,N'-diphenyl-N,N'-
17 bis(3-methylphenyl)-1,1'-biphenyl-4,4'-diamine dissolved in 75 ml of 1:1 volume ratio
18 of tetrahydrofuran/toluene. This slurry was then placed on a shaker for 10 minutes.
19 The resulting slurry was thereafter extrusion coated onto the adhesive interface layer to
20 form a coating layer having a wet thickness of 0.5 mil (12.7 micrometers). However, a
21 strip about 10 mm wide along one edge of the substrate bearing the blocking layer and
22 the adhesive layer was deliberately left uncoated by any of the photogenerating layer
23 material to facilitate adequate electrical contact by a ground strip layer that was applied
24 later. This photogenerating layer was dried at 125°C to form a dry photogenerating
25 layer 18 having a thickness of 2.0 micrometers.

26 This coated imaging member web was simultaneously extrusion overcoated with
27 a charge transport layer ("CTL") and a ground strip layer using a 3 mil gap Bird
28 applicator. The charge transport layer was prepared by introducing into an amber glass
29 bottle a weight ratio of 1:1 N,N'-diphenyl-N,N'-bis(3-methylphenyl)-1,1'-biphenyl-
30 4,4'-diamine and Makrolon 5705, a polycarbonate resin having a weight average
31 molecular weight of about 120,000 commercially available from Farbensabricken
32 Bayer A.G. The resulting mixture was dissolved to give a 15 percent by weight solids
33 in 85 percent by weight methylene chloride. This solution was applied over the
34 photogenerator layer to form a coating which, upon drying, gave a CTL thickness of 24

micrometers, a thermal contraction coefficient of $6.5 \times 10^{-5}/^{\circ}\text{C}$, and a glass transition temperature, T_g , of about 85°C .

The approximately 10 mm wide strip of the adhesive layer left uncoated by the photogenerator layer was coated with a ground strip layer during a co-coating process. This ground strip layer, after drying at 125°C in an oven and eventual cooling to room ambient, had a dried thickness of about 14 micrometers. This ground strip was electrically grounded, by conventional means such as a carbon brush contact means during conventional xerographic imaging process. The electrophotographic imaging member web stock, at this point if unrestrained, would spontaneously curl upwardly into a $1\frac{1}{2}$ inch diameter tube due to the thermal contraction mismatch between the CTL and the substrate support layer, resulting in greater CTL dimensional shrinkage than the substrate support layer, thereby causing substantial internal stress built-up in the CTL. The curled electrophotographic imaging member web stock was used to serve as a control.

CONTROL EXAMPLE II

Another flexible electrophotographic imaging member web stock was prepared by following the procedures and using materials as described in the Control Example I, but with the exception that the imaging member web stock curling was controlled by application of an anticurl backing layer to render imaging member web stock flatness.

An anticurl backing layer coating solution was prepared by combining 8.82 grams of polycarbonate resin (Makrolon 5705, available from Bayer AG), 0.72 gram of polyester resin (Vitel PE-200, available from Goodyear Tire and Rubber Company) and 90.1 grams of methylene chloride in a glass container to form a coating solution containing 8.9 percent by weight solids. The container was covered tightly and placed on a roll mill for about 24 hours until the polycarbonate and polyester were dissolved in the methylene chloride to form the anticurl coating solution. The anticurl backing layer coating solution was then applied to the rear surface of the substrate support layer (the side opposite the photogenerator layer and charge transport layer) of the imaging member web stock and dried at 125°C to produce a dried anticurl backing layer thickness of about 13.5 micrometers. The resulting electrophotographic imaging member web stock had the desired flatness and is a complete imaging member device. The fabricated electrophotographic imaging member web stock was also used to serve as an imaging member control.

1
2 INVENTION EXAMPLE I

3 The flexible electrophotographic imaging member web stock device of Control
4 Example II was used as follows. In essence, the imaging member web stock was
5 unwound from a 6,000 feet roll-up imaging member supply roll and was directed (with
6 the CTL facing outwardly, under a one pound per linear inch width web tension, and a
7 web stock transport speed of about 10 feet per minute) toward a one-inch outer
8 diameter free rotation processing treatment metal tube 206 having an arcuate outer
9 surface 210, and an annulus 209. The imaging member web stock, under 25 °C
10 ambient temperature, made an entering contact at 12 O'clock with the tube 206 and
11 conformed to the arcuate surface 210. A powerful infrared emitting tungsten halogen
12 quartz heating source 103, positioned directly above, brought upon an instant localized
13 temperature elevation to the CTL to about 10 °C above its T_g to facilitate molecular
14 motion and effect instant stress release from the CTL while the segment of the imaging
15 member web stock was in bending conformance contact over the arcuate surface 210.
16 The heating source 103 was an integrated unit having a length sufficiently covering the
17 whole width of the imaging member segment; it consists of a hemi-ellipsoidal cross-
18 section elongated reflector 106 and a halogen quartz tube 105 positioned at one focal
19 point inside the reflector 106 such that all the infrared radiant energy emitted from tube
20 105 was reflected and converged at the other focal point outside the reflector 106 to
21 give a 6 millimeters width focused heating region 108 that effected instant CTL
22 temperature elevation beyond its T_g.

23 The heated segment of CTL after exposure to the heating region 108 began to
24 cool down to below the glass transition temperature, through direct heat conduction to
25 tube 206 and heat transfer to ambient air, as the imaging member web stock in
26 continuous motion was transported away from heat source 103. A further and final
27 CTL cooling was assured by air impingement from an air knife directing a high
28 velocity narrow stream of cool air of about 19 °C onto the surface of the imaging
29 member from a 90 psi air supply line positioned at 4 O'clock to the tube 206 prior to
30 the imaging member web stock segment emerging from the curved contact zone region
31 to complete the treatment process.

32
33 INVENTION EXAMPLE II

34 The flexible electrophotographic imaging member web stock having no anticurl
35 back coating layer, prepared according to Control Example I, was similarly CTL stress

1 release treated by the procedures described in the preceding Invention Example I to
2 give good results, but with the exception that the air impingement cooling device was
3 replaced by the cooling system 203 of FIG. 1 employing a polyvinylalcohol
4 hydrophilic cooling foam roll saturated and partially submersed in a water cooling bath.
5 The temperature of the water cooling bath was about 5 degrees C. The foam roll was
6 driven by movement of the imaging member web stock. After being subjected to the
7 inventive method, the imaging member web stock was free of upward edge curling.

8 9 COMPARATIVE EXAMPLE I

10 The flexible electrophotographic imaging member web stock having no anticurl
11 backing layer, prepared according to Control Example I, was treated according to a
12 prior art method. In brief, the imaging member web stock emerged from a coater oven
13 at a temperature of about 100 °C (15 °C above the Tg of the CTL), with a one pound
14 per linear inch width applied web tension, and a web stock transporting speed of 70 feet
15 per minute. The distance between the coater oven exit and the beginning of the contact
16 zone was about 2 feet. The web stock was directed towards a one inch diameter metal
17 treatment tube maintained by a constant 15°C cooling water passing through the
18 treatment tube annulus. The transported hot imaging member web stock made a 12
19 O'clock entering contact with the treatment tube and remained in constant contact to
20 the surface of the treatment tube without employing any external cooling device for
21 further CTL cooling prior to the web stock leaving the treatment tube at 6 O'clock
22 position (i.e., a wrap angle of about 180 degrees), such cooling to complete the imaging
23 member web stock treatment in a continuous process. Surprisingly, the imaging
24 member web stock obtained after through this particular processing treatment was not
25 effective to totally eliminate the edge curl problem.

26 27 MECHANICAL BELT CYCLING TEST EXAMPLE

28 The flexible electrophotographic imaging member web stocks of Control
29 Example II and Invention Examples I and II were each cut to precise dimensions of 440
30 mm width and 2,808 mm in length. The opposite ends of each cut imaging member
31 sheet was secured to give 1 millimeter overlap and ultrasonically welded, utilizing 40
32 KHz horn frequency, in the long dimension, to form a seamed flexible imaging member
33 belt for fatigue dynamic electrophotographic imaging test in a selected xerographic
34 machine.

1 Prior to carrying out the dynamic cycling belt test, the seam splashings were
2 measured and analyzed with the use of a Wyko Gauze NT-200 for physical
3 dimensions. The seam of imaging member belts prepared from web stock having the
4 material composition and structure of Control Example II and Invention Example I
5 gave an average seam splashing height of about 79 micrometers and a width of about
6 0.85 millimeter. By comparison, the splashings of the seamed belt prepared from the
7 imaging member web stock of Invention Example II had about 40% splash size
8 reduction both in height and width directions since that imaging member had a
9 simplified material make-up structure with no anticurl backing layer in the molten mass
10 ejection to form seam splashing.

11 The dynamic machine belt cycling test results obtained showed that the onset of
12 seam cracking/delamination failure was significantly delayed by about 2 times for the
13 imaging member belts prepared with the web stock treated by the inventive methods of
14 Invention Examples I and II as compared to the seam life for the belt prepared from the
15 non-stress release treated web stock of Control Example II. The results seen for belt
16 flexing induced charge transport layer fatigue cracking due to constant dynamic
17 bending over machine belt support module rollers were even more encouraging because
18 the onset of charge transport layer cracking was notably delayed by almost 4 times for
19 the belts fabricated with the imaging member web stocks of Invention Examples I and
20 II as compared with the control belt counterpart prepared from the web stock of Control
21 Example II.

22 The physical analysis and mechanical belt cycling test results seen in seam
23 splashing size reduction, fatigue seam cracking/delamination failure suppression, and
24 significant charge transport layer cracking life extension were all achieved for the belts
25 prepared using the imaging member web stocks treated with the present stress release
26 method. The present method also did not adversely affect the chemical, mechanical, or
27 electrical properties of the imaging member, thereby maintaining the dedicate photo-
28 electrical function of the imaging member.

29 Other modifications of the present invention may occur to those skilled in the
30 art based upon a reading of the present disclosure and these modifications are
31 intended to be included within the scope of the present invention.